



Specification

1.General Characteristics :

- . Contact Principle : Friction Technology
- . Mounting System : SMT
- . Durability : 10,000 Cycles Min.

2. Material

- . Data Contacts Material : Phosphor Bronze
- ⚠. Data Contacts Plating : Gold Over Nickel
- . Insulation Material : Thermoplastic UL 94V-0

3. Electrical Characteristics

- ⚠. Contact Resistance : 50 Milliohms Max.,
- . Insulator Resistance : >1000 Megohms/500V DC

4. Solderability

- . Wave : Not Applicable
- . Vapor Phase : 215°C, 30 Sec. Max.
- . IR Reflow : 260°C, 15 Sec. Max.
- . Manual Soldering : 360°C, 3 Sec. Max.

5. Environmental Characteristics

- . Operating Temperature : -40°C ~ +85°C
- . Operating Humidity : 10% ~ 95% RH
- . Storage Temperature : -40°C ~ +85°C
- . Storage Humidity : 10% ~ 95% RH
- RoHS Compliant

P.C.B LAYOUT(Tolerance:±0.05mm)

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例 参考	UNLESS OTHERWISE SPECIFIED TOLERANCES ARE .X ±0.38 .XX ±0.25 ANG. ±1°	PART NAME 品名 SIM CARD SLIDE IN TYPE 6PIN SMT 90° ROW PITCH=12.1mm H=2.4mm WITHOUT LOCATING PEG & WITHOUT SWITCH GOLD FLASH PLATING ROHS
DWG. 製圖 Betty	UNIT 單位 MM	SIZE. 紙張尺寸 A 4	PART NO. 料號 C0610-06BBAGBXR
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